

Integrated Device Technology, Inc. 6024 Silver Creek Valley Road, San Jose, CA 95138

PRODUCT/PROCESS CHANGE NOTICE (PCN)						
PCN #: B1311-01 DATE: Product Affected: 89HT0816P (Refer to Attachment I for Date Effective: March 24, 2014	,	MEANS OF DIST ■ Product Mark □ Back Mark □ Date Code □ Other		HANGED DEVICES: n orderable part#		
Contact: IDT PCN DESK		Attachment:	Yes	☐ No		
E-mail: <u>pcndesk@idt.com</u>		I	et your local sales and datasheet rec	representative for quests.		
DESCRIPTION AND PURPOSE OF CHANGE: □ Die Technology □ Wafer Fabrication Process □ Assembly Process □ Equipment □ Material □ Testing □ Manufacturing Site □ Data Sheet □ Other - Die Revision Change □ Other - Die Revision Change □ Please see attachment for details. This notification is to advise our customers that IDT has qualified a new die revision to address the device errata. The device die revision will change from Rev YB to Rev YD. □ Material □ There will be a change in ordering part number and device top mark. There is no change to die technology/process. The new die revision is fully hardware and software compatible with the previous revision. ■ Other - Die Revision Change □ Please see attachment for details. RELIABILITY/QUALIFICATION SUMMARY: There is no change in die technology/process.						
CUSTOMER ACKNOWLEDGMENT OF RECEIPT: IDT records indicate that you require written notification of this change. Please use the acknowledgement below or E-Mail to grant approval or request additional information. If IDT does not receive acknowledgement within 30 days of this notice it will be assumed that this change is acceptable. IDT reserves the right to ship either version manufactured after the process change effective date until the inventory on the earlier version has been depleted.						
Customer:		Approval fo	or shipments p	rior to effective date.		
Name/Date:	E-N	Mail Address:				
Title:	Pho	one # /Fax #:				
CUSTOMER COMMENTS:						
IDT ACKNOWLEDGMENT OF RECEIPT:						
RECD. BY:		DATE:				

Integrated Device Technology, Inc. 6024 Silver Creek Valley Road, San Jose, CA 95138

PRODUCT/PROCESS CHANGE NOTICE (PCN)

ATTACHMENT I - PCN #: B1311-01

PCN Type: Die Revision Change

Data Sheet Change: No

Detail of Change:

This notification is to advise our customers that IDT has qualified a new die revision to address the device errata. The device die revision will change from Rev YB to Rev YD.

There will be a change in the ordering part number and device top mark. There is no change to die technology/process. The new die revision is fully hardware and software compatible with the previous revision.

The new die revision will address the known errata item as shown in Table 1.

Table 1

Errata Item	Affected Devices	"YB" Revision	"YD" Revision
Hot Reset in cascaded mode may not work	All	The use of the cascaded mode of Retimer may result in a deadlock condition.	Fixed
EQCONST.SLOWEQ default setting may not result in the best EQ	All	The default setting of the Slow EQ field of the EQCONST register may result in sub-optimal link quality.	Fixed
Port leaves link disabled state in 2ms without waiting for exit from EI	All	Premature exit in 2ms from link disabled state may cause unpredictable system behavior.	Fixed
Speed change failure results in Gen1 only training in some cases	All	During link training process the Retimer port could misses the speed change, and the speed change attempt fails.	Fixed
L0s to L0 transition may send transmit unaligned data (Gen1/2 only)	All	Transitions from L0s to L0 may result in unaligned data being transmitted which may lead to Recovery.	Fixed
PCTL.USESKPLSFR default value needs to be changed	All	If the LFSR value happens to be bad this may result in erroneous behavior in the Retimer.	Fixed
Link may end up at Gen1 speeds when two retimers are cascaded	All	Misalignment during de-skewing process may result in link failure which may result in the link ending up at Gen1 speed.	Fixed

Note: please refer to the device errata document for full detail.



PRODUCT/PROCESS CHANGE NOTICE (PCN)

ATTACHMENT I - PCN #: B1311-01

Table 2

<u> 1 able 2</u>				
Old Ordering Part Number	New Ordering Part Number			
89HT0808PYBAB	89HT0808PYDAB			
89HT0808PYBAB8	89HT0808PYDAB8			
89HT0808PYBABG	89HT0808PYDABG			
89HT0808PYBABG8	89HT0808PYDABG8			
89HT0808PYBABGI	89HT0808PYDABGI			
89HT0808PYBABGI8	89HT0808PYDABGI8			
89HT0808PYBABI	89HT0808PYDABI			
89HT0808PYBABI8	89HT0808PYDABI8			
89HT0812PYBBC	89HT0812PYDBC			
89HT0812PYBBC8	89HT0812PYDBC8			
89HT0812PYBBCG	89HT0812PYDBCG			
89HT0812PYBBCG8	89HT0812PYDBCG8			
89HT0812PYBBCGI	89HT0812PYDBCGI			
89HT0812PYBBCGI8	89HT0812PYDBCGI8			
89HT0812PYBBCI	89HT0812PYDBCI			
89HT0812PYBBCI8	89HT0812PYDBCI8			
89HT0816PYBBC	89HT0816PYDBC			
89HT0816PYBBC8	89HT0816PYDBC8			
89HT0816PYBBCG	89HT0816PYDBCG			
89HT0816PYBBCG8	89HT0816PYDBCG8			
89HT0816PYBBCGI	89HT0816PYDBCGI			
89HT0816PYBBCGI8	89HT0816PYDBCGI8			
89HT0816PYBBCI	89HT0816PYDBCI			
89HT0816PYBBCI8	89HT0816PYDBCI8			

Qualification Test Plan and Result:

Qualification Plan #: QI-13-04

Qual Vehicle: 89HT0816PYDZDBCG

Test Description	Test Method (Latest specs in effect)	Test Results (SS / Rej)
Operating Lifetest (Dynamic) 125°C@500 Hrs	JESD22-A108	0/77
ESD: Human Body Model @ 2000V	JESD22-A115	0/3
ESD: Charged Device Model @ 500V	JESD22-C101	0/3
Latch-up	JESD78	0/6

Note: * Test require moisture pre-conditioning sequence per JEDEC J-STD-020